# 1926736-2 ACTIVE

#### **MINIPAK**

TE Internal #: 1926736-2

Rectangular Power Connectors, Header, Plug, Board-to-Board, 85 Position, 2 mm / 2.75 mm [.079 in / .108 in] Centerline, Printed

Circuit Board

View on TE.com >



Connectors > Power Connectors > Rectangular Power > Rectangular Power Connectors



Rectangular Power Connector Type: Header

Connector & Housing Type: Plug
Connector System: Board-to-Board

Number of Positions: 85

Centerline (Pitch): 2 mm, 2.75 mm [ .079 in, .108 in ]

### **Features**

# **Product Type Features**

Header Type	Fully Shrouded
Rectangular Power Connector Type	Header
Connector & Housing Type	Plug
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

# **Configuration Features**

Number of Positions by Circuit Application	25/Signal, 10/DC Power
Mating & Unmating Configuration	Make First / Break Last
Number of Positions	85
PCB Mount Orientation	Right Angle
Number of Power Positions	10
Number of Signal Positions	25
Number of Rows	5
Board-to-Board Configuration	Co-Planar
Electrical Characteristics	

Operating Voltage	250 VDC
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### **Contact Features**



PCB Contact Termination Area Plating Material Thickness  Contact Underplating Material Thickness  1.27 μm[50 μin]  Contact Mating Area Plating Material  Contact Shape & Form  Single Beam  Contact Underplating Material  Nickel  Contact Base Material  Copper  Contact Current Rating (Max)  16 A, 17 A  Contact Retention Within Housing  With  Contact Type  PCB Contact Termination Area Plating Material  Tin  Contact Mating Area Plating Material Thickness  3 μm, 30 μm[.08 μin][.76 – .83 μin]  Termination Features  Termination Post & Tail Length  Termination Method to Printed Circuit Board  Mechanical Attachment
Contact Mating Area Plating Material  Contact Shape & Form  Single Beam  Contact Underplating Material  Nickel  Contact Base Material  Contact Current Rating (Max)  16 A, 17 A  Contact Retention Within Housing  With  Contact Type  Blade, Pin  PCB Contact Termination Area Plating Material  Tin  Contact Mating Area Plating Material Thickness  3 µm, 30 µm[.08 µin][.76 – .83 µin]  Termination Features  Termination Post & Tail Length  3.3 mm[.13 in]  Termination Method to Printed Circuit Board  Through Hole - Press-Fit, Through Hole - Solder
Contact Shape & Form  Contact Underplating Material  Contact Base Material  Contact Current Rating (Max)  Contact Retention Within Housing  With  Contact Type  Blade, Pin  PCB Contact Termination Area Plating Material  Contact Mating Area Plating Material Thickness  Termination Features  Termination Post & Tail Length  Termination Method to Printed Circuit Board  Single Beam  Nickel  Copper  16 A, 17 A  With  Tin  Tin  Tin  Ton  Ton  Ton  Ton  Tin  Termination Features  Termination Features  Termination Post & Tail Length  Through Hole - Press-Fit, Through Hole - Solder
Contact Underplating Material Contact Base Material Contact Current Rating (Max) 16 A, 17 A  Contact Retention Within Housing With  Contact Type Blade, Pin  PCB Contact Termination Area Plating Material Tin  Contact Mating Area Plating Material Thickness 3 µm, 30 µm[.08 µin][.76 – .83 µin]  Termination Features  Termination Post & Tail Length 3.3 mm[.13 in]  Termination Method to Printed Circuit Board Through Hole - Press-Fit, Through Hole - Solder
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Termination Post & Tail Length  3.3 mm[.13 in]  Termination Method to Printed Circuit Board  Through Hole - Press-Fit, Through Hole - Solder
Termination Method to Printed Circuit Board  Through Hole - Press-Fit, Through Hole - Solder
Solder
Mechanical Attachment
PCB Mount Alignment Type Screw Mount
Mating Alignment Type Passive Guide
Mating Retention Without
Mating Alignment With
PCB Mount Alignment With
PCB Mount Retention With
PCB Mount Retention Type Screw Mount
Connector Mounting Type Board Mount
Housing Features
Centerline (Pitch) 2 mm, 2.75 mm[.079 in][.108 in]
Housing Color Black
Housing Material Thermoplastic
Dimensions
Connector Height 8 mm[.315 in]
PCB Thickness (Recommended) .06 mm[1.4 in]
Product Width 26.5 mm[1.043 in]
Product Length 51.71 mm[2.04 in]



Row-to-Row Spacing	2 mm[.079 in]
Usage Conditions	
Operating Temperature Range	-40 – 125 °C[-40 – 257 °F]
Operation/Application	
Circuit Application	Power & Signal
Industry Standards	
CSA Rating	Certified
UL Rating	Recognized
Agency/Standard	CSA
Approved Standards	UL E28476
UL Flammability Rating	UL 94V-0
Glow Wire Rating	Standard Part - Not Glow Wire
Packaging Features	
Packaging Method	Box

# **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides



on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# Compatible Parts



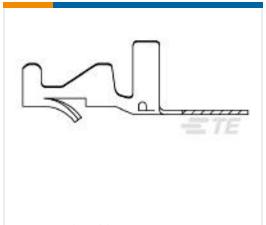
# Customers Also Bought













**ASSEMBLY** 



TE Part #61505-2 RING TINSEL WIRE TPBR









# **Documents**

Product Drawings
MiniPAK HDL, 25s10p, RA Plug,

English



### **CAD Files**

**Customer View Model** 

ENG\_CVM\_CVM\_1926736-2\_C.2d\_dxf.zip

English

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_1926736-2\_C.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_1926736-2\_C.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

# Datasheets & Catalog Pages

2\_PIECE\_POWER\_CONNECTORS\_qrg\_4-1773458-1

English

# **Product Specifications**

**Application Specification** 

English

**Product Environmental Compliance** 

MD\_1926736-2\_110720172356\_dmtec

English

MD\_1926736-2\_110720172356\_dmtec

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